Microchip Technology - DSPIC33CK256MP508T-I/PT Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	100MHz
Connectivity	CANbus, I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, QEI, WDT
Number of I/O	69
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	24K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 24x12b; D/A 3x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-TQFP
Supplier Device Package	80-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ck256mp508t-i-pt

2.4 ICSP Pins

The PGCx and PGDx pins are used for ICSP and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of Ohms, not to exceed 100 Ohms.

Pull-up resistors, series diodes and capacitors on the PGCx and PGDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits and pin Voltage Input High (V_{IH}) and Voltage Input Low (V_{IL}) requirements.

Ensure that the "Communication Channel Select" (i.e., PGCx/PGDx pins) programmed into the device matches the physical connections for the ICSP to PICkit™ 3, MPLAB® ICD 3 or MPLAB REAL ICE™ emulator.

For more information on MPLAB ICD 2, MPLAB ICD 3 and REAL ICE emulator connection requirements, refer to the following documents that are available on the Microchip web site.

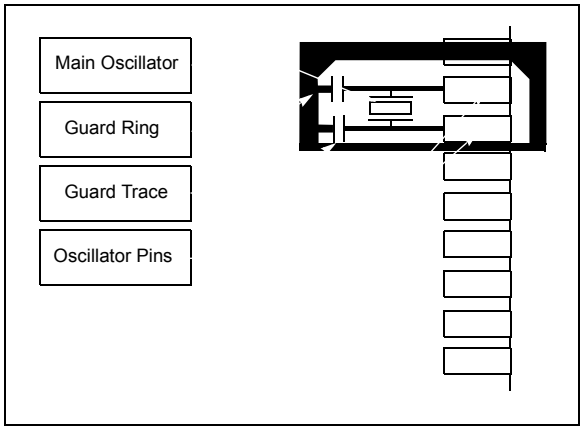
- *"Using MPLAB® ICD 3 In-Circuit Debugger"* (poster) (DS51765)
- *"Development Tools Design Advisory"* (DS51764)
- *"MPLAB® REAL ICE™ In-Circuit Emulator User's Guide"* (DS51616)
- *"Using MPLAB® REAL ICE™ In-Circuit Emulator"* (poster) (DS51749)

2.5 External Oscillator Pins

Many DSCs have options for at least two oscillators: a high-frequency Primary Oscillator (POSC) and a low-frequency Secondary Oscillator (SOSC). For details, see **Section 9.2 "Primary Oscillator (POSC)"**.

The oscillator circuit should be placed on the same side of the board as the device. Also, place the oscillator circuit close to the respective oscillator pins, not exceeding one-half inch (12 mm) distance between them. The load capacitors should be placed next to the oscillator itself, on the same side of the board. Use a grounded copper pour around the oscillator circuit to isolate them from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed. A suggested layout is shown in Figure 2-3.

FIGURE 2-3: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT



REGISTER 3-2: CORCON: CORE CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-0
VAR	—	US1	US0	EDT(1)	DL2	DL1	DL0
bit 15							bit 8

R/W-0	R/W-0	R/W-1	R/W-0	R/C-0	R-0	R/W-0	R/W-0
SATA	SATB	SATDW	ACCSAT	IPL3(2)	SFA	RND	IF
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **VAR:** Variable Exception Processing Latency Control bit
1 = Variable exception processing is enabled
0 = Fixed exception processing is enabled

bit 14 **Unimplemented:** Read as '0'

bit 13-12 **US<1:0>:** DSP Multiply Unsigned/Signed Control bits
11 = Reserved
10 = DSP engine multiplies are mixed sign
01 = DSP engine multiplies are unsigned
00 = DSP engine multiplies are signed

bit 11 **EDT:** Early DO Loop Termination Control bit(1)
1 = Terminates executing DO loop at the end of the current loop iteration
0 = No effect

bit 10-8 **DL<2:0>:** DO Loop Nesting Level Status bits
111 = 7 DO loops are active
...
001 = 1 DO loop is active
000 = 0 DO loops are active

bit 7 **SATA:** ACCA Saturation Enable bit
1 = Accumulator A saturation is enabled
0 = Accumulator A saturation is disabled

bit 6 **SATB:** ACCB Saturation Enable bit
1 = Accumulator B saturation is enabled
0 = Accumulator B saturation is disabled

bit 5 **SATDW:** Data Space Write from DSP Engine Saturation Enable bit
1 = Data Space write saturation is enabled
0 = Data Space write saturation is disabled

bit 4 **ACCSAT:** Accumulator Saturation Mode Select bit
1 = 9.31 saturation (super saturation)
0 = 1.31 saturation (normal saturation)

bit 3 **IPL3:** CPU Interrupt Priority Level Status bit 3(2)
1 = CPU Interrupt Priority Level is greater than 7
0 = CPU Interrupt Priority Level is 7 or less

Note 1: This bit is always read as '0'.
2: The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU Interrupt Priority Level.

6.0 RESETS

Note 1: This data sheet summarizes the features of the dsPIC33CK256MP508 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Reset"** (DS70602) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices.

The Reset module combines all Reset sources and controls the device Master Reset Signal, $\overline{SYSRST}$. The following is a list of device Reset sources:

- POR: Power-on Reset
- BOR: Brown-out Reset
- $\overline{MCLR}$: Master Clear Pin Reset
- SWR: RESET Instruction
- WDTO: Watchdog Timer Time-out Reset
- CM: Configuration Mismatch Reset
- TRAPR: Trap Conflict Reset
- IOPUWR: Illegal Condition Device Reset
  - Illegal Opcode Reset
  - Uninitialized W Register Reset
  - Security Reset

A simplified block diagram of the Reset module is shown in Figure 6-1.

Any active source of Reset will make the $\overline{SYSRST}$ signal active. On system Reset, some of the registers associated with the CPU and peripherals are forced to a known Reset state, and some are unaffected.

Note: Refer to the specific peripheral section or **Section 4.0 "Memory Organization"** of this data sheet for register Reset states.

All types of device Reset set a corresponding status bit in the RCON register to indicate the type of Reset (see Register 6-1).

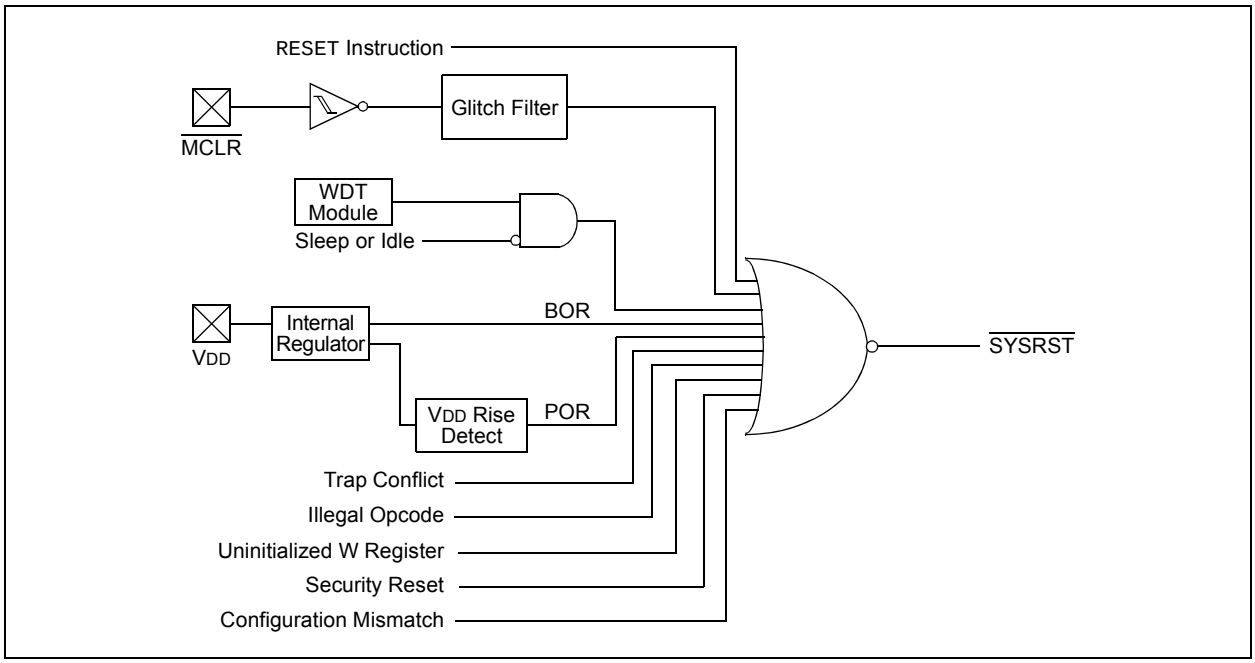
A POR clears all the bits, except for the BOR and POR bits (RCON<1:0>) that are set. The user application can set or clear any bit, at any time, during code execution. The RCON bits only serve as status bits. Setting a particular Reset status bit in software does not cause a device Reset to occur.

The RCON register also has other bits associated with the Watchdog Timer and device power-saving states. The function of these bits is discussed in other sections of this data sheet.

Note: The status bits in the RCON register should be cleared after they are read so that the next RCON register value after a device Reset is meaningful.

For all Resets, the default clock source is determined by the FNOSC<2:0> bits in the FOSCSEL Configuration register. The value of the FNOSCx bits is loaded into the NOSC<2:0> (OSCCON<10:8>) bits on Reset, which in turn, initializes the system clock.

FIGURE 6-1: RESET SYSTEM BLOCK DIAGRAM



REGISTER 7-1: SR: CPU STATUS REGISTER(1)

R/W-0	R/W-0	R/W-0	R/W-0	R/C-0	R/C-0	R-0	R/W-0
OA	OB	SA	SB	OAB	SAB	DA	DC
bit 15							bit 8

R/W-0(3)	R/W-0(3)	R/W-0(3)	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL2(2)	IPL1(2)	IPL0(2)	RA	N	OV	Z	C
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1'= Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5 **IPL<2:0>:** CPU Interrupt Priority Level Status bits(2,3)
111 = CPU Interrupt Priority Level is 7 (15); user interrupts are disabled
110 = CPU Interrupt Priority Level is 6 (14)
101 = CPU Interrupt Priority Level is 5 (13)
100 = CPU Interrupt Priority Level is 4 (12)
011 = CPU Interrupt Priority Level is 3 (11)
010 = CPU Interrupt Priority Level is 2 (10)
001 = CPU Interrupt Priority Level is 1 (9)
000 = CPU Interrupt Priority Level is 0 (8)

Note 1: For complete register details, see Register 3-1.
2: The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL, if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.
3: The IPL<2:0> Status bits are read-only when the NSTDIS bit (INTCON1<15>) = 1.

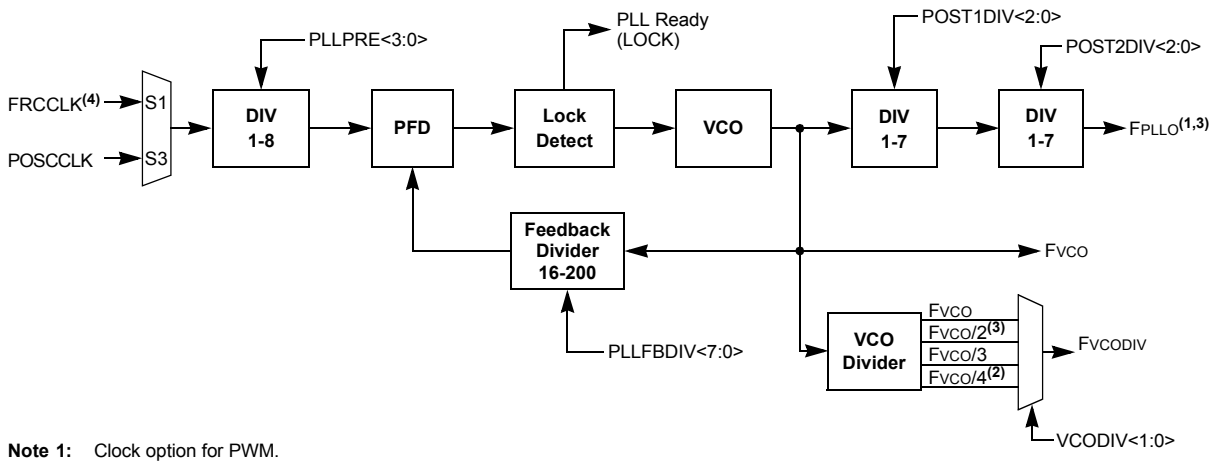
The Primary Oscillator and internal FRC Oscillator sources can optionally use an on-chip PLL to obtain higher operating speeds. Figure 9-3 illustrates a block diagram of the PLL module.

For PLL operation, the following requirements must be met at all times without exception:

- The PLL Input Frequency (F_{PLLI}) must be in the range of 8 MHz to 64 MHz
- The PFD Input Frequency (F_{PFD}) must be in the range of 8 MHz to (F_{VCO}/16) MHz

The VCO Output Frequency (F_{VCO}) must be in the range of 400 MHz to 1600 MHz

FIGURE 9-3: PLL AND VCO DETAIL



Note 1: Clock option for PWM.
2: Clock option for ADC.
3: Clock option for DAC.
4: PLL source is always FRC unless FNOSC is the Primary Oscillator with PLL.

9.6 Oscillator Control Registers

REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER(1)

U-0	R-0	R-0	R-0	U-0	R/W-y	R/W-y	R/W-y
—	COSC2	COSC1	COSC0	—	NOSC2(2)	NOSC1(2)	NOSC0(2)
bit 15							bit 8

R/W-0	U-0	R-0	U-0	R/W-0	U-0	U-0	R/W-0
CLKLOCK	—	LOCK	—	CF(3)	—	—	OSWEN
bit 7							bit 0

Legend:	y = Value set from Configuration bits on POR		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **COSC<2:0>:** Current Oscillator Selection bits (read-only)
111 = Fast RC Oscillator (FRC) with Divide-by-n (FRCDIVN)
110 = Backup FRC (BFRC)
101 = Low-Power RC Oscillator (LPRC)
100 = Reserved – default to FRC
011 = Primary Oscillator (XT, HS, EC) with PLL (XTPLL, HSPLL, ECPLL)
010 = Primary Oscillator (XT, HS, EC)
001 = Fast RC Oscillator (FRC) with PLL (FRCPLL)
000 = Fast RC Oscillator (FRC)

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **NOSC<2:0>:** New Oscillator Selection bits(2)
111 = Fast RC Oscillator (FRC) with Divide-by-n (FRCDIVN)
110 = Backup FRC (BFRC)
101 = Low-Power RC Oscillator (LPRC)
100 = Reserved – default to FRC
011 = Primary Oscillator (XT, HS, EC) with PLL (XTPLL, HSPLL, ECPLL)
010 = Primary Oscillator (XT, HS, EC)
001 = Fast RC Oscillator (FRC) with PLL (FRCPLL)
000 = Fast RC Oscillator (FRC)

bit 7 **CLKLOCK:** Clock Lock Enable bit
1 = If (FCKSM0 = 1), then clock and PLL configurations are locked; if (FCKSM0 = 0), then clock and PLL configurations may be modified
0 = Clock and PLL selections are not locked, configurations may be modified

bit 6 **Unimplemented:** Read as '0'

bit 5 **LOCK:** PLL Lock Status bit (read-only)
1 = Indicates that PLL is in lock or PLL start-up timer is satisfied
0 = Indicates that PLL is out of lock, start-up timer is in progress or PLL is disabled

bit 4 **Unimplemented:** Read as '0'

Note 1: Writes to this register require an unlock sequence.

2: Direct clock switches between any Primary Oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transitional clock source between the two PLL modes.

3: This bit should only be cleared in software. Setting the bit in software (= 1) will have the same effect as an actual oscillator failure and will trigger an oscillator failure trap.

NOTES:

REGISTER 11-46: C1BDIAG0H: CAN BUS DIAGNOSTICS REGISTER 0 HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
DTERRCNT<7:0>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
DRERRCNT<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **DTERRCNT<7:0>:** Data Bit Rate Transmit Error Counter bits

bit 7-0 **DRERRCNT<7:0>:** Data Bit Rate Receive Error Counter bits

REGISTER 11-47: C1BDIAG0L: CAN BUS DIAGNOSTICS REGISTER 0 LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
NTERRCNT<7:0>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
NRERRCNT<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **NTERRCNT<7:0>:** Nominal Bit Rate Transmit Error Counter bits

bit 7-0 **NRERRCNT<7:0>:** Nominal Bit Rate Receive Error Counter bits

REGISTER 12-10: PWMEVTy: PWM EVENT OUTPUT CONTROL REGISTER y(5) (CONTINUED)

bit 2-0 **EVTyPGS<2:0>:** PWM Event Source Selection bits(2)

111 = PWM Generator 8
110 = PWM Generator 7
. . .
000 = PWM Generator 1

Note 1: The event signal is stretched using peripheral_clk because different PWM Generators may be operating from different clock sources.

2: No event will be produced if the selected PWM Generator is not present.

3: This is the PWM Generator output signal prior to output mode logic and any output override logic.

4: This signal should be the PGx_clk domain signal prior to any synchronization into the system clock domain.

5: 'y' denotes a common instance (A-F).

REGISTER 14-9: SLPxCONL: DACx SLOPE CONTROL LOW REGISTER (CONTINUED)

bit 11-8 **SLPSTOPA<3:0>:** Slope Stop A Signal Select bits

The selected Slope Stop A signal is logically OR'd with the selected Slope Stop B signal to terminate the slope function.

Slope Stop A Signal Selection	Master
1101-1111	1
1000	PWM8 Trigger 2
0111	PWM7 Trigger 2
0110	PWM6 Trigger 2
0101	PWM5 Trigger 2
0100	PWM4 Trigger 2
0011	PWM3 Trigger 2
0010	PWM2 Trigger 2
0001	PWM1 Trigger 2
0000	0

bit 7-4 **SLPSTOPB<3:0>:** Slope Stop B Signal Select bits

The selected Slope Stop B signal is logically OR'd with the selected Slope Stop A signal to terminate the slope function.

Slope Start B Signal Selection	Master
0100-1111	1
0011	CMP3 Out
0010	CMP2 Out
0001	CMP1 Out
0000	0

bit 3-0 **SLPSTRT<3:0>:** Slope Start Signal Select bits

Slope Start Signal Selection	Master
1101-1111	1
1000	PWM8 Trigger 1
0111	PWM7 Trigger 1
0110	PWM6 Trigger 1
0101	PWM5 Trigger 1
0100	PWM4 Trigger 1
0011	PWM3 Trigger 1
0010	PWM2 Trigger 1
0001	PWM1 Trigger 1
0000	0

REGISTER 16-16: UxSCINT: UARTx SMART CARD INTERRUPT REGISTER

U-0	U-0	R/W-0, HS	R/W-0, HS	U-0	R/W-0, HS	R/W-0, HS	R/W-0, HS
—	—	RXRPTIF	TXRPTIF	—	BTCIF	WTCIF	GTCIF
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
—	—	RXRPTIE	TXRPTIE	—	BTCIE	WTCIE	GTCIE
bit 7							bit 0

Legend:	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **RXRPTIF:** Receive Repeat Interrupt Flag bit
1 = Parity error has persisted after the same character has been received five times (four retransmits)
0 = Flag is cleared

bit 12 **TXRPTIF:** Transmit Repeat Interrupt Flag bit
1 = Line error has been detected after the last retransmit per TXRPT<1:0>
0 = Flag is cleared

bit 11 **Unimplemented:** Read as '0'

bit 10 **BTCIF:** Block Time Counter Interrupt Flag bit
1 = Block Time Counter has reached 0
0 = Block Time Counter has not reached 0

bit 9 **WTCIF:** Waiting Time Counter Interrupt Flag bit
1 = Waiting Time Counter has reached 0
0 = Waiting Time Counter has not reached 0

bit 8 **GTCIF:** Guard Time Counter Interrupt Flag bit
1 = Guard Time Counter has reached 0
0 = Guard Time Counter has not reached 0

bit 7-6 **Unimplemented:** Read as '0'

bit 5 **RXRPTIE:** Receive Repeat Interrupt Enable bit
1 = An interrupt is invoked when a parity error has persisted after the same character has been received five times (four retransmits)
0 = Interrupt is disabled

bit 4 **TXRPTIE:** Transmit Repeat Interrupt Enable bit
1 = An interrupt is invoked when a line error is detected after the last retransmit per TXRPT<1:0> has been completed
0 = Interrupt is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2 **BTCIE:** Block Time Counter Interrupt Enable bit
1 = Block Time Counter interrupt is enabled
0 = Block Time Counter interrupt is disabled

bit 1 **WTCIE:** Waiting Time Counter Interrupt Enable bit
1 = Waiting Time Counter interrupt is enabled
0 = Waiting Time Counter Interrupt is disabled

bit 0 **GTCIE:** Guard Time Counter interrupt enable bit
1 = Guard Time Counter interrupt is enabled
0 = Guard Time Counter interrupt is disabled

TABLE 18-2: I2Cx RESERVED ADDRESSES(1)

Slave Address	R/$\overline{W}$ Bit	Description
0000 000	0	General Call Address(2)
0000 000	1	Start Byte
0000 001	x	Cbus Address
0000 01x	x	Reserved
0000 1xx	x	HS Mode Master Code
1111 0xx	x	10-Bit Slave Upper Byte(3)
1111 1xx	x	Reserved

Note 1: The address bits listed here will never cause an address match independent of address mask settings.

2: This address will be Acknowledged only if GCEN = 1.

3: A match on this address can only occur on the upper byte in 10-Bit Addressing mode.

NOTES:

22.3 Output Compare Mode

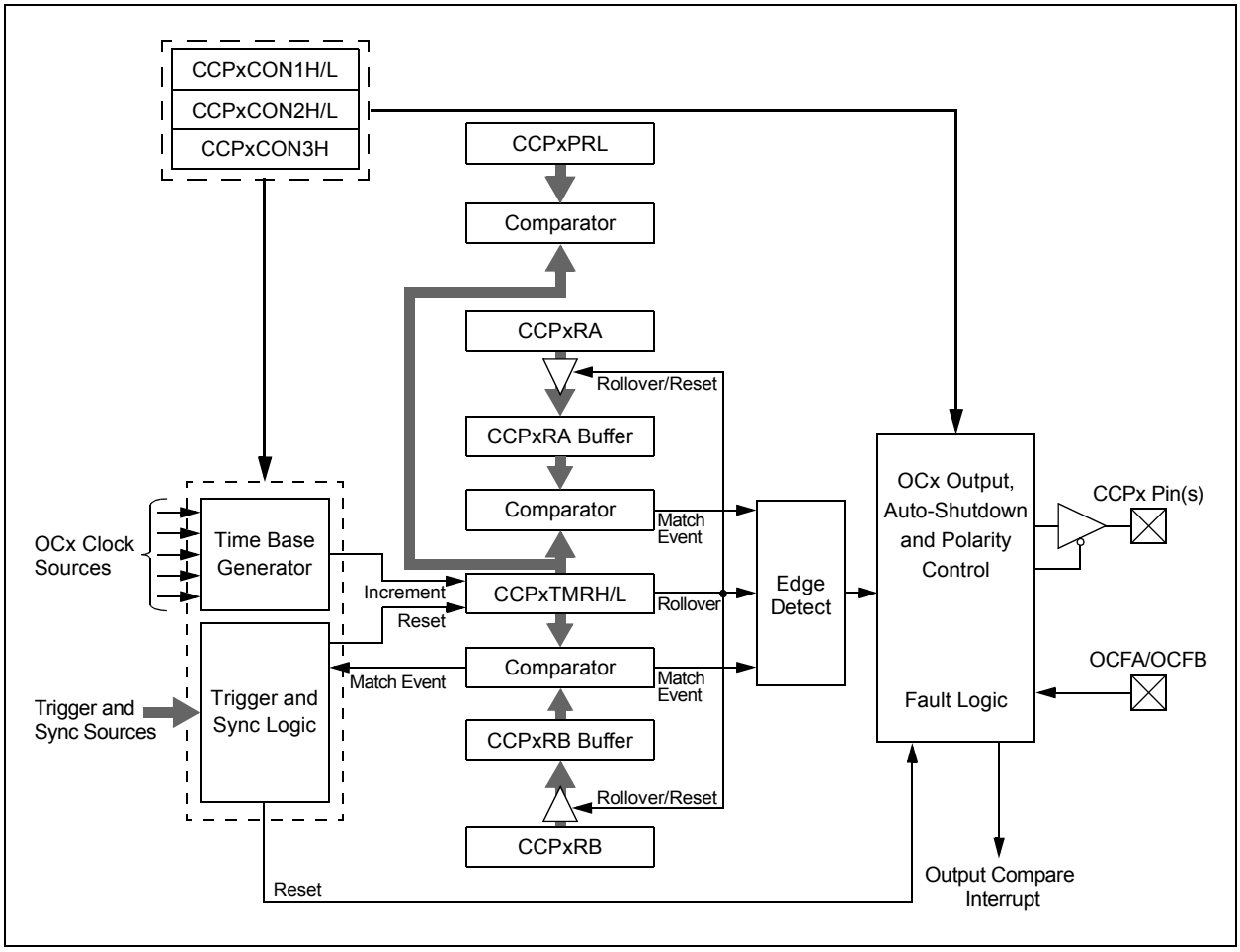
Output Compare mode compares the Timer register value with the value of one or two Compare registers, depending on its mode of operation. The Output Compare x module, on compare match events, has the ability to generate a single output transition or a train of output pulses. Like most PIC® MCU peripherals, the Output Compare x module can also generate interrupts on a compare match event.

Table 22-2 shows the various modes available in Output Compare modes.

TABLE 22-2: OUTPUT COMPARE x/PWMx MODES

MOD<3:0> (CCPxCON1L<3:0>)	T32 (CCPxCON1L<5>)	Operating Mode	
0001	0	Output High on Compare (16-bit)	Single Edge Mode
0001	1	Output High on Compare (32-bit)	
0010	0	Output Low on Compare (16-bit)	
0010	1	Output Low on Compare (32-bit)	
0011	0	Output Toggle on Compare (16-bit)	
0011	1	Output Toggle on Compare (32-bit)	
0100	0	Dual Edge Compare (16-bit)	Dual Edge Mode
0101	0	Dual Edge Compare (16-bit buffered)	PWM Mode

FIGURE 22-5: OUTPUT COMPARE x BLOCK DIAGRAM



24.2 PTG Registers

REGISTER 24-1: PTGCST: PTG CONTROL/STATUS LOW REGISTER

R/W-0	U-0	R/W-0	R/W-0	U-0	R/W-0, HC	R/W-0	R/W-0
PTGEN	—	PTGSIDL	PTGTOGL	—	PTGSWT(2)	PTGSSEN(3)	PTGIVIS
bit 15							bit 8

R/W-0, HC	R/W-0, HS	R/W-0, HS, HC	U-0	U-0	U-0	R/W-0	R/W-0
PTGSTRT	PTGWDTO	PTGBUSY	—	—	—	PTGITM1(1)	PTGITM0(1)
bit 7							bit 0

Legend:	HC = Hardware Clearable bit	HS = Hardware Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **PTGEN:** PTG Enable bit
1 = PTG is enabled
0 = PTG is disabled

bit 14 **Unimplemented:** Read as '0'

bit 13 **PTGSIDL:** PTG Freeze in Debug Mode bit
1 = Halts PTG operation when device is Idle
0 = PTG operation continues when device is Idle

bit 12 **PTGTOGL:** PTG Toggle Trigger Output bit
1 = Toggles state of TRIG output for each execution of PTGTRIG
0 = Generates a single TRIG pulse for each execution of PTGTRIG

bit 11 **Unimplemented:** Read as '0'

bit 10 **PTGSWT:** PTG Software Trigger bit(2)
1 = Toggles state of TRIG output for each execution of PTGTRIG
0 = Generates a single TRIG pulse for each execution of PTGTRIG

bit 9 **PTGSSEN:** PTG Single-Step Command bit(3)
1 = Enables single Step when in Debug mode
0 = Disables single Step

bit 8 **PTGIVIS:** PTG Counter/Timer Visibility bit
1 = Reading the PTGSDLIM, PTGCxLIM or PTGTxLIM registers returns the current values of their corresponding Counter/Timer registers (PTGSDLIM, PTGCxLIM and PTGTxLIM)
0 = Reading the PTGSDLIM, PTGCxLIM or PTGTxLIM registers returns the value of these Limit registers

bit 7 **PTGSTRT:** PTG Start Sequencer bit
1 = Starts to sequentially execute the commands (Continuous mode)
0 = Stops executing the commands

bit 6 **PTGWDTO:** PTG Watchdog Timer Time-out Status bit
1 = PTG Watchdog Timer has timed out
0 = PTG Watchdog Timer has not timed out

bit 5 **PTGBUSY:** PTG State Machine Busy bit
1 = PTG is running on the selected clock source; no SFR writes are allowed to PTGCLK<2:0> or PTGDIV<4:0>
0 = PTG state machine is not running

Note 1: These bits apply to the PTGWHI and PTGWLO commands only.
2: This bit is only used with the PTGCTRL Step command software trigger option.
3: The PTGSSEN bit may only be written when in Debug mode.

TABLE 24-2: PTG COMMAND OPTIONS (CONTINUED)

bit 3-0	Step Command	OPTION<3:0>	Option Description
	PTGWHI(1) or PTGWLO(1)	0000	PTGI0 (see Table 24-3 for input assignments).
		• • •	• • •
		1111	PTGI15 (see Table 24-3 for input assignments).
	PTGIRQ(1)	0000	Generate PTG Interrupt 0.
		• • •	• • •
		0111	Generate PTG Interrupt 7.
		1000	Reserved; do not use.
		• • •	• • •
		1111	Reserved; do not use.
	PTGTRIG	00000	PTGO0 (see Table 24-4 for output assignments).
		00001	PTGO1 (see Table 24-4 for output assignments).
		• • •	• • •
		11110	PTGO30 (see Table 24-4 for output assignments).
		11111	PTGO31 (see Table 24-4 for output assignments).
	PTGWHI(1) or PTGWLO(1)	0000	PTGI0 (see specific device data sheet for input assignments).
		• • •	• • •
		1111	PTGI15 (see specific device data sheet for input assignments).
	PTGIRQ(1)	0000	Generate PTG Interrupt 0 (see specific device data sheet for interrupt assignments).
		• • •	• • •
		0111	Generate PTG Interrupt 7 (see specific device data sheet for interrupt assignments).
		1000	Reserved; do not use.
		• • •	• • •
		1111	Reserved; do not use.
	PTGTRIG	00000	PTGO0 (see specific device data sheet for assignments).
		00001	PTGO1 (see specific device data sheet for assignments).

Note 1: All reserved commands or options will execute, but they do not have any affect (i.e., execute as a NOP instruction).

30.2 Device Calibration and Identification

The dsPIC33CK256MP508 devices have two Identification registers, near the end of configuration memory space, that store the Device ID (DEVID) and Device Revision (DEVREV). These registers are used to determine the mask, variant and manufacturing information about the device. These registers are read-only and are shown in Register 30-18 and Register 30-19.

REGISTER 30-18: DEVREV: DEVICE REVISION REGISTER

R	R	R	R	R	R	R	R
DEVREV<23:16>							
bit 23							bit 16

R	R	R	R	R	R	R	R
DEVREV<15:8>							
bit 15							bit 8

R	R	R	R	R	R	R	R
DEVREV<7:0>							
bit 7							bit 0

Legend:	R = Read-only bit	U = Unimplemented bit

bit 23-0 **DEVREV<23:0>:** Device Revision bits

REGISTER 30-19: DEVID: DEVICE ID REGISTERS

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

R	R	R	R	R	R	R	R
FAMID7	FAMID6	FAMID5	FAMID4	FAMID3	FAMID2	FAMID1	FAMID0
bit 15							bit 8

R	R	R	R	R	R	R	R
DEV7(1)	DEV6(1)	DEV5(1)	DEV4(1)	DEV3(1)	DEV2(1)	DEV1(1)	DEV0(1)
bit 7							bit 0

Legend:	R = Read-only bit	U = Unimplemented bit

bit 23-16 **Unimplemented:** Read as '1'

bit 15-8 **FAMID<7:0>:** Device Family Identifier bits

`0111 1100` = dsPIC33CK256MP508 family

bit 7-0 **DEV<7:0>:** Individual Device Identifier bits(1)

Note 1: See Table 30-4 for the list of Device Identifier bits.

30.3 User OTP Memory

The dsPIC33CK256MP508 family devices contain 64 One-Time-Programmable (OTP) double words, located at addresses, 801700h through 8017FEh. Each 48-bit OTP double word can only be written one time. The OTP Words can be used for storing checksums, code revisions, manufacturing dates, manufacturing lot numbers or any other application-specific information.

The OTP area is not cleared by any erase command. This memory can be written only once.

30.4 On-Chip Voltage Regulators

dsPIC33CK256MP508 family devices have a capacitor-less internal voltage regulator to supply power to the core at 1.2V (typical).

A pair of voltage regulators, VREG1 and VREG2 together, provide power for the core. The PLL is powered using a separate regulator, VREGPLL, as shown in Figure 30-1.

The regulators have Low-Power and Standby modes for use in Sleep modes. For additional information about Sleep, see **Section 29.2.1 "Sleep Mode"**.

When the regulators are in Low-Power mode (LPWREN = 1), the power available to the core is limited. Before the LPWREN bit is set, the device should be placed into a lower power state by disabling peripherals and lowering CPU frequency (e.g., 8 MHz FRC without PLL).

The output voltages of the three regulators can be controlled independently by the user, which gives the capability to save additional power during Sleep mode.

FIGURE 30-1: INTERNAL REGULATOR

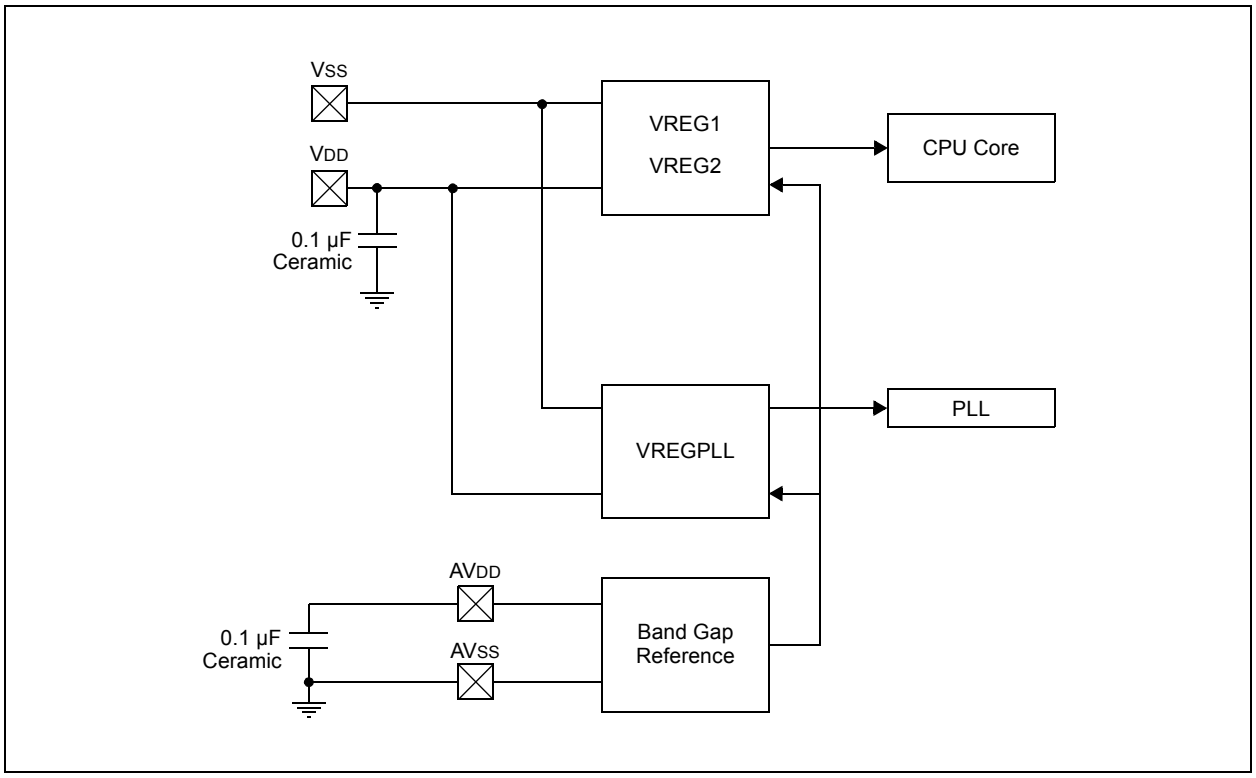


TABLE 33-9: WATCHDOG TIMER DELTA CURRENT (ΔIWDT)(1)

Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended					
Parameter No.	**Typ.**	**Max.**	**Units**	**Conditions**	
DC61	0.75	5	µA	-40°C	3.3V
	2.0	12	µA	+25°C	
	3.88	24	µA	+85°C	
	5.69	40	µA	+125°C	

Note 1: The ΔIWDT current is the additional current consumed when the module is enabled. This current should be added to the base IPD current. All parameters are characterized but not tested during manufacturing.

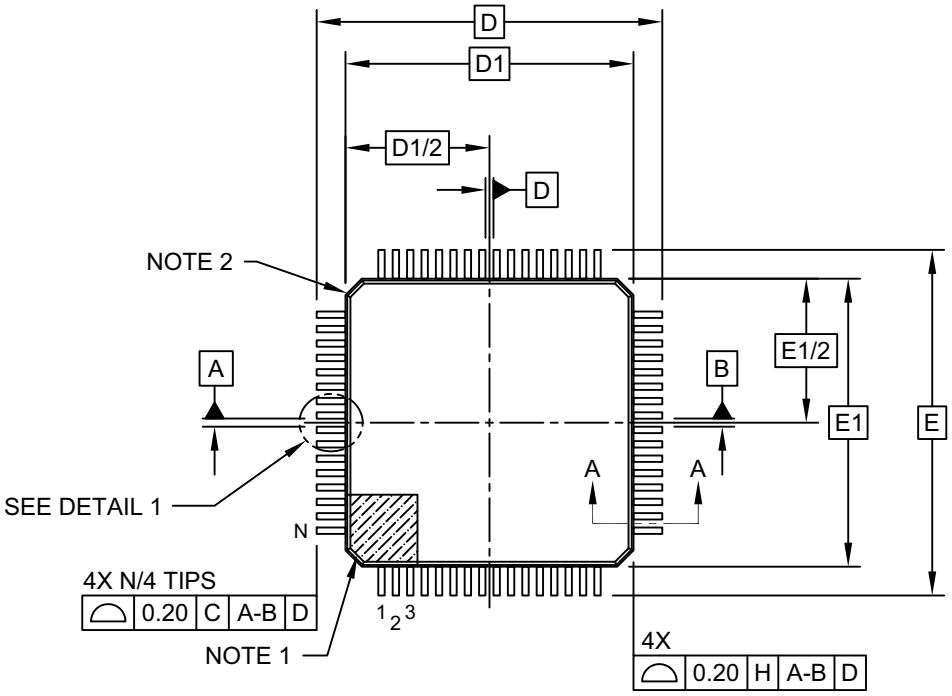
TABLE 33-10: PWM DELTA CURRENT(1)

Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended						
Parameter No.	**Typ.**	**Max.**	**Units**	**Conditions**		
DC100	5.96	6.6	mA	-40°C	3.3V	PWM Input (AFPLLO = 500 MHz) (AVCO = 1000 MHz, PLLFBD = 125, APLLDIV1 = 2)
	5.99	6.7	mA	+25°C		
	5.92	6.9	mA	+85°C		
	5.47	7	mA	+125°C		
DC101	4.89	5.4	mA	-40°C	3.3V	PWM Input (AFPLLO = 400 MHz), (AVCO = 400 MHz, PLLFBD = 50, APLLDIV1 = 1)
	4.91	5.5	mA	+25°C		
	4.85	5.7	mA	+85°C		
	4.42	5.7	mA	+125°C		
DC102	2.77	3.7	mA	-40°C	3.3V	PWM Input (AFPLLO = 200 MHz), (AVCO = 400 MHz, PLLFBD = 50, APLLDIV1 = 2)
	2.75	3.7	mA	+25°C		
	2.7	3.7	mA	+85°C		
	2.26	3.7	mA	+125°C		
DC103	1.67	2	mA	-40°C	3.3V	PWM Input (AFPLLO = 100 MHz), (AVCO = 400 MHz, PLLFBD = 50, APLLDIV1 = 4)
	1.66	2.2	mA	+25°C		
	1.63	2.3	mA	+85°C		
	1.17	2.3	mA	+125°C		

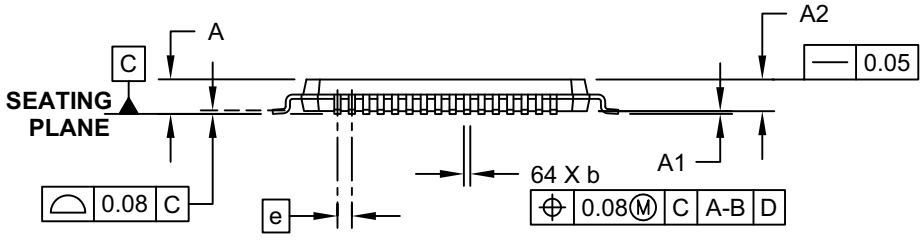
Note 1: APLL current is not included. The APLL current will be the same if more than 1 PWM is running. Listed delta currents are for only one PWM instance. All parameters are characterized but not tested during manufacturing.

64-Lead Plastic Thin Quad Flatpack (PT)-10x10x1 mm Body, 2.00 mm Footprint [TQFP]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW

Microchip Technology Drawing C04-085C Sheet 1 of 2